NX5L2750C

Analog switch with negative swing audio capability Rev. 2 — 7 May 2014 Production

Product data sheet

General description 1.

The NX5L2750C is a dual low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2:1 multiplexer/demultiplexer. Each switch has a digital select input (nS), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ).

The NX5L2750C can switch audio signals with negative swing without the need of a coupling capacitor.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. It makes it possible for the NX5L2750C to switch 5 V audio signals with a 1.8 V digital controller, eliminating the need for logic level translation.

Features and benefits

- Supply voltage range from 1.8 V to 5.0 V
- 0.8 Ω typical ON resistance
- 100 MHz typical bandwidth or data frequency
- CMOS low-power consumption
- 1.8 V control logic at V_{CC} = 3.6 V
- Break-before-make switching
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4000 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- Specified from -40 °C to +85 °C

Applications 3.

- Cellular phones, PDA
- Portable media players
- Personal media players



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4. Ordering information

Table 1. Ordering information

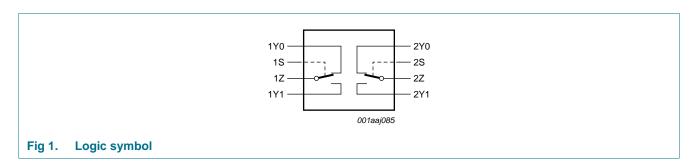
Type number	Package						
	Temperature range	Name	Description	Version			
NX5L2750CGU	–40 °C to +85 °C	XQFN10	plastic, extremely thin quad flat package; no leads; 10 terminals; body 1.40 \times 1.80 \times 0.50 mm	SOT1160-1			

5. Marking

Table 2. Marking

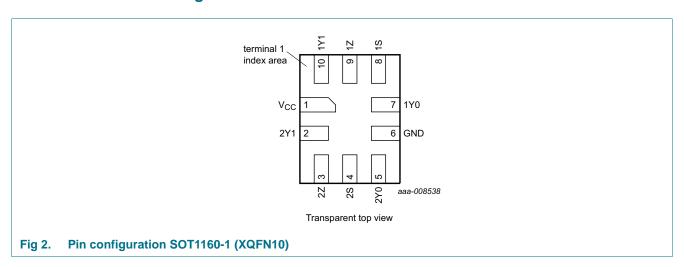
Type number	Marking code
NX5L2750CGU	LA

6. Functional diagram



7. Pinning information

7.1 Pinning



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7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
V _{CC}	1	supply voltage
2Y0, 1Y0	5, 7	independent input or output
2Z, 1Z	3, 9	common output or input
2S, 1S	4, 8	select input
GND	6	ground (0 V)
2Y1, 1Y1	2, 10	independent input or output

8. Functional description

Table 4. Function table[1]

Input (nS)	Channel on
L	nY0 = nZ
Н	nY1 = nZ

^[1] H = HIGH voltage level; L = LOW voltage level.

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+5.5	V
VI	input voltage	pins nS	-0.5	+5.5	V
V _{SW}	switch voltage		-4.0	V _{CC} + 0.5	V
I _{IK}	input clamping current	V _I < -0.5 V	-50	-	mA
I _{SK}	switch clamping current	$V_1 < -4.0 \text{ V or } V_1 > V_{CC} + 0.5 \text{ V}$	-	±50	mA
I _{SW}	switch current	T _{amb} = 25 °C	-	±250	mA
		T _{amb} = 25 °C; peak current (pulsed at 1 ms duration; < 10 % duty cycle)	-	±500	mA
I _{CC}	supply current		-	+50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	-	250	mW

^[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		1.8	5.0	V

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Table 6. Recommended operating conditions ...continued

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage	pins nS	0	5.0	V
V_{SW}	switch voltage	<u>[1]</u>	-2.5	V _{CC}	V
T _{amb}	ambient temperature		-40	+85	°C

^[1] The voltage across the switch should be < 5.5 V.

11. Static characteristics

Table 7. Static characteristics

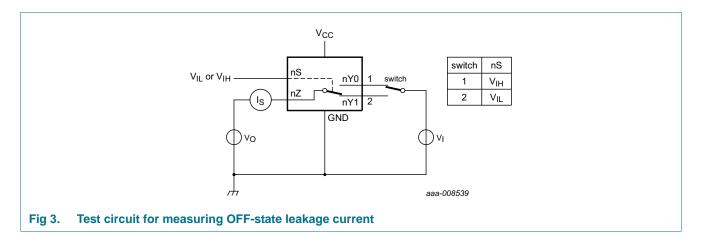
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	T _{amb} =	= −40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	
V _{IH}	HIGH-level input	V _{CC} = 2.7 V to 4.3 V	1.4	-	-	V
	voltage	V _{CC} = 4.3 V to 5.0 V	1.5	-	-	V
V _{IL}	LOW-level input	V _{CC} = 2.7 V to 4.3 V	-	-	0.6	V
	voltage	V _{CC} = 4.3 V to 5.0 V	-	-	0.6	V
V _{IK}	input clamping voltage	$V_{CC} = 3.0 \text{ V}; I_I = -18 \text{ mA}$	-	-	-1.2	V
II	input leakage current	pins nS; $V_I = 0 \text{ V to V}_{CC}$; $V_{CC} = 0 \text{ V to 4.3 V}$	-	-	±1	μΑ
I _{S(OFF)}	OFF-state leakage current	$V_{CC} = 2.7 \text{ V}; V_{I} = -2.5 \text{ V or } 2.5 \text{ V};$ $V_{O} = 2.5 \text{ V or } -2.5 \text{ V};$ see Figure 3	-	-	±250	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC} ; $V_{CC} = 2.7 \text{ V}$	-	-	2	μΑ
Δl _{CC}	additional supply current	V_I = 2.6 V; V_{SW} = GND or V_{CC} ; V_{CC} = 4.3 V	-	-	10	μΑ
		V_I = 1.8 V; V_{SW} = GND or V_{CC} ; V_{CC} = 4.3 V	-	-	15	μΑ
Cı	input capacitance	pins nS	-	1.5	-	pF
C _{S(OFF)}	OFF-state capacitance	pins nY0 and nY1; V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	35	-	pF
C _{S(ON)}	ON-state capacitance	pins nZ; $V_{CC} = 3.3 \text{ V}$; $V_{I} = 0 \text{ V}$ to 3.3 V	-	75	-	pF

^[1] Typical values are measured at T_{amb} = 25 $^{\circ}C$ and V_{CC} = 3.3 V.

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11.1 Test circuits



11.2 ON resistance

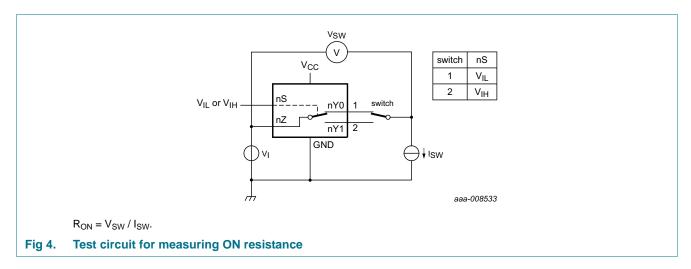
Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol Parameter		Conditions		-40 °C to +85 °C		
			Min	Typ[1]	Max	
R _{ON}	ON resistance	$V_1 = V_{CC} - 4.5 \text{ V to } V_{CC}; I_{SW} = 100 \text{ mA}; V_{CC} = 2.7 \text{ V};$ see Figure 4	-	0.8	1.3	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_I = V_{CC} - 4.5 \text{ V to } V_{CC}; I_{SW} = 100 \text{ mA}; V_{CC} = 2.7 \text{ V};$ see Figure 4	-	0.3	-	Ω
ΔR _{ON}	ON resistance mismatch between channels	$V_I = V_{CC} - 4.5 \text{ V}$; $I_{SW} = 100 \text{ mA}$; $V_{CC} = 2.7 \text{ V}$; see Figure 4	-	0.1	-	Ω

- [1] Typical values are measured at $T_{amb} = 25$ °C.
- [2] Measured at identical V_{CC}, temperature and input voltage.

11.3 ON resistance test circuit and graphs



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12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 7.

Symbol	Parameter	Conditions		T _{amb} =	-40 °C to	Unit	
						Max	
t _{en}	enable time	nS to nZ; see Figure 5					
		V _{CC} = 2.7 V to 3.6 V	[2]	-	80	160	ns
		V _{CC} = 3.6 V to 4.3 V	<u>[3]</u>	-	70	120	ns
t _{dis}	disable time	nS to nZ; see Figure 5					
		V _{CC} = 2.7 V to 3.6 V	[2]	-	25	50	ns
		V _{CC} = 3.6 V to 4.3 V	<u>[3]</u>	-	25	50	ns
t _{b-m}	break-before-make time	see Figure 6	<u>[4]</u>				
		V _{CC} = 2.7 V to 3.6 V		15	55	-	ns
		V _{CC} = 3.6 V to 4.3 V		12	45	-	ns

- [1] Typical values are measured at T_{amb} = 25 °C.
- [2] Typical values are measured at $V_{CC} = 3.3 \text{ V}$.
- [3] Typical values are measured at $V_{CC} = 4.3 \text{ V}$.
- [4] Guaranteed by design.

12.1 Waveform and test circuits

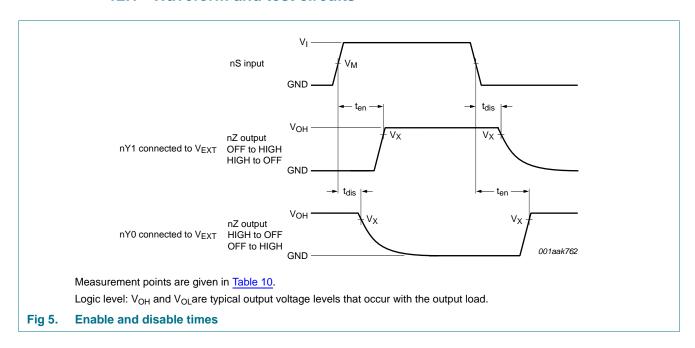


Table 10. Measurement points

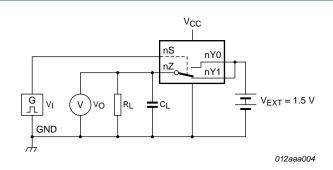
Supply voltage	Input	Output	
V _{CC}	V _M	VI	V _X
2.7 V to 4.3 V	0.5V _{CC}	V _{CC}	0.9V _{OH}

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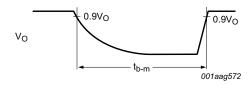
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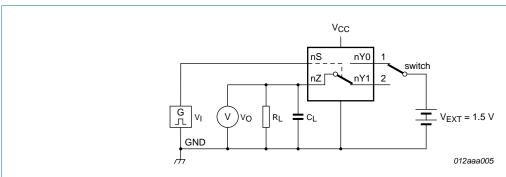
a. Test circuit.





b. Input and output measurement points

Fig 6. Test circuit for measuring break-before-make timing



Test data is given in Table 11.

Definitions test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 V_{EXT} = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load		
V _{CC}	V _I	t _r , t _f	C _L	R _L	
2.7 V to 4.3 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω	

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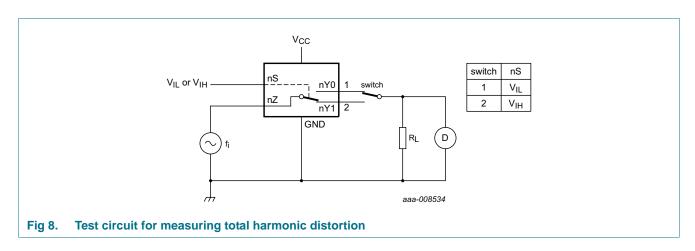
12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V). $V_I = \text{GND}$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

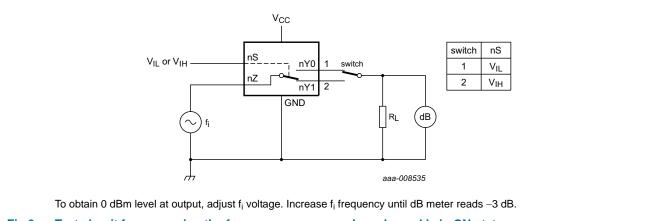
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic distortion	f_i = 20 Hz to 20 kHz; R_L = 32 Ω ; see Figure 8				
		$V_{CC} = 2.7 \text{ V}; V_{I} = 2 \text{ V (p-p)}$	-	0.07	-	%
		$V_{CC} = 4.3 \text{ V}; V_I = 2 \text{ V (p-p)}$	-	0.03	-	%
f _(-3dB)	-3 dB frequency response	$R_L = 50 \Omega$; see Figure 9				
		V _{CC} = 2.7 V to 4.3 V	-	100	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}$; $R_L = 50 \Omega$; see Figure 10				
		V _{CC} = 2.7 V to 4.3 V	-	-60	-	dB
Xtalk	crosstalk	between switches; f_i = 100 kHz; R_L = 50 Ω ; see Figure 11				
		V _{CC} = 2.7 V to 4.3 V	-	-60	-	dB
Q _{inj}	charge injection	f_i = 1 MHz; C_L = 0.1 nF; R_L = 1 M Ω ; V_{gen} = 0 V; R_{gen} = 0 Ω ; see Figure 12				
		V _{CC} = 2.7 V	-	3	-	рС
		V _{CC} = 3.3 V	-	4	-	рС
		V _{CC} = 4.3 V	-	5	-	рС

12.3 Test circuits



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Test circuit for measuring the frequency response when channel is in ON-state Fig 9.

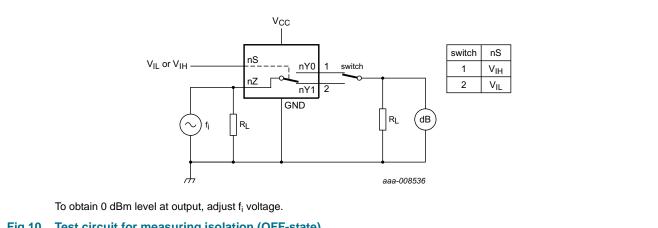
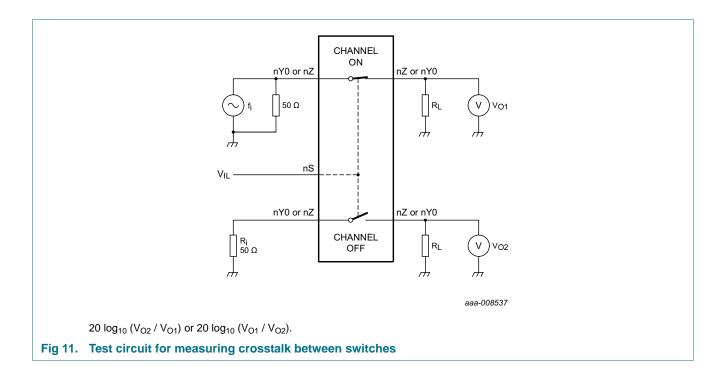
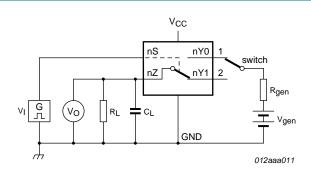


Fig 10. Test circuit for measuring isolation (OFF-state)

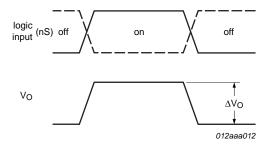
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a. Test circuit



b. Input and output pulse definitions

Definition: $Q_{inj} = \Delta V_O \times C_L$.

 ΔV_{O} = output voltage variation.

R_{gen} = generator resistance.

 V_{gen} = generator voltage.

Fig 12. Test circuit for measuring charge injection

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13. Package outline

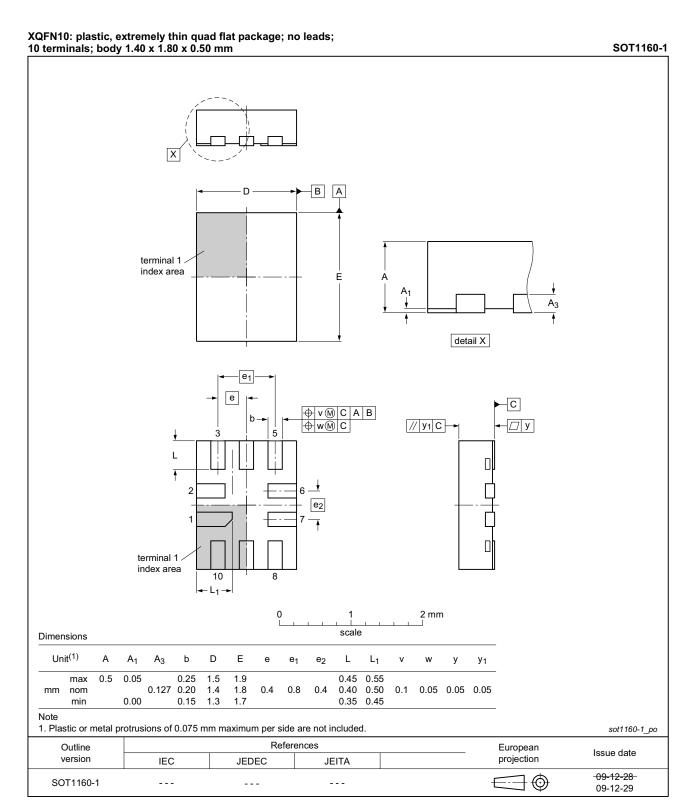


Fig 13. Package outline SOT1160-1 (XQFN10)

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14. Abbreviations

Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic
UART	Universal Asynchronous Receiver/Transmitter
USB	Universal Serial Bus

15. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5L2750C v.2	20140507	Product data sheet	-	NX5L2750C v.1
Modifications:	 <u>Table 7</u>: minimum V_{IH} level added at V_{CC} = 4.3 V to 5.0 V 			
	 <u>Table 7</u>: minimum V_{IL} level added at V_{CC} = 4.3 V to 5.0 V 			
NX5L2750C v.1	20130906	Product data sheet	-	-

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Document status[1][2]	Product status[3]	Definition
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